

# Power TOPLED Hyper-Bright LED

LW E673 www.DataSheet4U.com



## Vorläufige Daten / Preliminary Data

### Besondere Merkmale

- **Gehäusetyp:** weißes P-LCC-4 Gehäuse
- **Besonderheit des Bauteils:** mehr Licht durch einen geringen thermischen Widerstand
- **Farbort:**  $x = 0,32$ ,  $y = 0,31$  nach CIE 1931 (weiß)
- **typische Farbtemperatur:** 6500 K
- **Farbwiedergabeindex:** 80
- **Abstrahlwinkel:** Lambertscher Strahler (120°)
- **Technologie:** InGaN
- **optischer Wirkungsgrad:** 6 lm/W
- **Gruppierungsparameter:** Lichtstärke, Farbort
- **Verarbeitungsmethode:** für alle SMT-Bestücktechniken geeignet
- **Lötmethode:** IR Reflow Löten und Wellenlöten (TTW)
- **Vorbehandlung:** nach JEDEC Level 2
- **Gurtung:** 8 mm Gurt mit 2000/Rolle,  $\varnothing 180$  mm oder 8000/Rolle,  $\varnothing 330$  mm
- **ESD-Festigkeit:** ESD-sicher bis 2 kV nach EOS/ESD-5.1-1993

### Anwendungen

- Verkehrssignale
- Hinterleuchtung (LCD, Schalter, Tasten, Displays, Werbebeleuchtung, Allgemeinbeleuchtung)
- Innen- und Außenbeleuchtung im Automobilbereich (z.B. Instrumentenbeleuchtung)
- Ersatz von Kleinst-Glühlampen
- Leselampen
- Rettungsnotleuchten
- Signal- und Symbolleuchten
- Markierungsbeleuchtung (z.B. Stufen, Fluchtwege, u.ä.)
- Scanner

### Features

- **package:** white P-LCC-4 package
- **feature of the device:** more brightness due to a lower thermal resistance
- **color coordinates:**  $x = 0.32$ ,  $y = 0.31$  acc. to CIE 1931 (white)
- **typ. color temperature:** 6500 K
- **color reproduction index:** 80
- **viewing angle:** Lambertian Emitter (120°)
- **technology:** InGaN
- **optical efficiency:** 6 lm/W
- **grouping parameter:** luminous intensity, color coordinates
- **assembly methods:** suitable for all SMT assembly methods
- **soldering methods:** IR reflow soldering and TTW soldering
- **preconditioning:** acc. to JEDEC Level 2
- **taping:** 8 mm tape with 2000/reel,  $\varnothing 180$  mm or 8000/reel,  $\varnothing 330$  mm
- **ESD-withstand voltage:** up to 2 kV acc. to EOS/ESD-5.1-1993

### Applications

- traffic signals
- backlighting (LCD, switches, keys, displays, illuminated advertising, general lighting)
- Interior and exterior automotive lighting (e.g. dashboard backlighting)
- substitution of micro incandescent lamps
- reading lamps
- emergency lighting
- signal and symbol luminaire
- marker lights (e.g. steps, exit ways, etc.)
- scanners

Typ Type	Emissions- farbe Color of Emission	Farbe der Lichtaustritts- fläche Color of the Light Emitting Area	Lichtstärke Luminous Intensity $I_F = 30 \text{ mA}$ $I_V \text{ (mcd)}$	Lichtstrom Luminous Flux $I_F = 30 \text{ mA}$ $\Phi_V \text{ (mlm)}$	Bestellnummer Ordering Code
LW E673-R2S2-1	white	colored	140 ... 280	610 (typ.)	Q62703-Q4862
LW E673-S2U1-1		diffused	224 ... 560	1100 (typ.)	Q62703-Q4902

Anm.: -1 Farbselektiert nach Farbortgruppen (siehe **Seite 5**)

*Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe, die aus nur 3 bzw. 4 Halbgruppen besteht. Einzelne Halbgruppen sind nicht erhältlich.  
In einer Verpackungseinheit / Gurt ist immer nur eine Halbgruppe enthalten.*

Note: -1 Color selection acc. to Chromaticity coordinate groups (see **page 5**)

*The standard shipping format for serial types includes a lower or upper family group of 3 or 4 individual groups. Individual half groups are not available.  
No packing unit / tape ever contains more than one luminous intensity half group.*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebstemperatur Operating temperature range	$T_{op}$	- 40 ... + 100	°C
Lagertemperatur Storage temperature range	$T_{stg}$	- 40 ... + 100	°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 110	°C
Durchlassstrom Forward current	$I_F$	30	mA
Stoßstrom Surge current $t \leq 10 \mu s, D = 0.005$	$I_{FM}$	200	mA
Sperrspannung Reverse voltage	$V_R$	5	V
Leistungsaufnahme Power consumption	$P_{tot}$	130	mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient	$R_{th JA}$	300	K/W
Sperrschicht/Löt看pad Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 16 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 16 \text{ mm}^2$ )	$R_{th JS}$	130	K/W

Kennwerte ( $T_A = 25\text{ °C}$ )

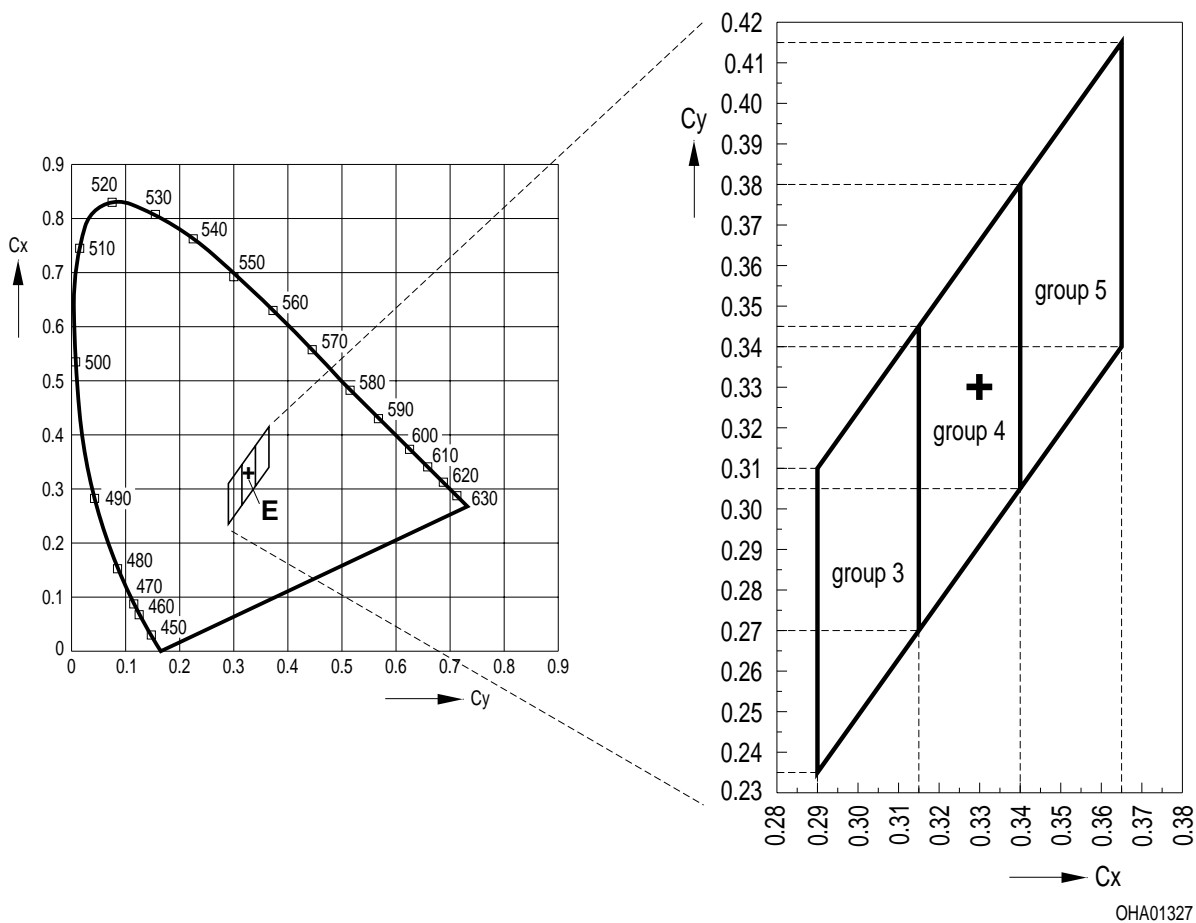
## Characteristics

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Farbkoordinate x nach CIE 1931 <sup>1)</sup> (typ.) Chromaticity coordinate x acc. to CIE 1931 $I_F = 30\text{ mA}$	x	0.32	–
Farbkoordinate y nach CIE 1931 <sup>1)</sup> (typ.) Chromaticity coordinate y acc. to CIE 1931 $I_F = 30\text{ mA}$	y	0.31	–
Abstrahlwinkel bei 50 % $I_V$ (Vollwinkel) (typ.) Viewing angle at 50 % $I_V$	$2\phi$	120	Grad deg.
Durchlassspannung <sup>2)</sup> (typ.) Forward voltage (max.) $I_F = 30\text{ mA}$	$V_F$ $V_F$	3.8 4.2	V V
Sperrstrom (typ.) Reverse current (max.) $V_R = 5\text{ V}$	$I_R$ $I_R$	0.01 10	$\mu\text{A}$ $\mu\text{A}$
Temperaturkoeffizient von x (typ.) Temperature coefficient of x $I_F = 30\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_x$	–0.1	$10^{-3}/\text{K}$
Temperaturkoeffizient von y (typ.) Temperature coefficient of y $I_F = 30\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_y$	–0.2	$10^{-3}/\text{K}$
Temperaturkoeffizient von $V_F$ (typ.) Temperature coefficient of $V_F$ $I_F = 30\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_V$	– 3.0	mV/K
Optischer Wirkungsgrad (typ.) Optical efficiency $I_F = 30\text{ mA}$	$\eta_{\text{opt}}$	6	lm/W

<sup>1)</sup> Farbortgruppen werden mit einer Stromeinprägungsdauer von 25 ms und einer Genauigkeit von  $\pm 0,01$  ermittelt.  
Chromaticity coordinate groups are tested at a current pulse duration of 25 ms and a tolerance of  $\pm 0.01$ .

<sup>2)</sup> Spannungswerte werden mit einer Stromeinprägungsdauer von 1 ms und einer Genauigkeit von  $\pm 0.1\text{ V}$  ermittelt.  
Voltages are tested at a current pulse duration of 1 ms and a tolerance of  $\pm 0.1\text{ V}$ .

1) Farbortgruppen  
Chromaticity coordinate groups



**Helligkeits-Gruppierungsschema**  
**Luminous Intensity Groups**

Lichtgruppe Luminous Intensity Group	Lichtstärke Luminous Intensity $I_V$ (mcd)	Lichtstrom Luminous Flux $\Phi_V$ (mlm)
R2	140 ... 180	480 (typ.)
S1	180 ... 224	600 (typ.)
S2	224 ... 280	760 (typ.)
T1	280 ... 355	950 (typ.)
T2	355 ... 450	1200 (typ.)
U1	450 ... 560	1500 (typ.)

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11\%$  ermittelt.  
 Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11\%$ .

**Gruppenbezeichnung auf Etikett**  
**Group Name on Label**

Beispiel: R2-4

Example: R2-4

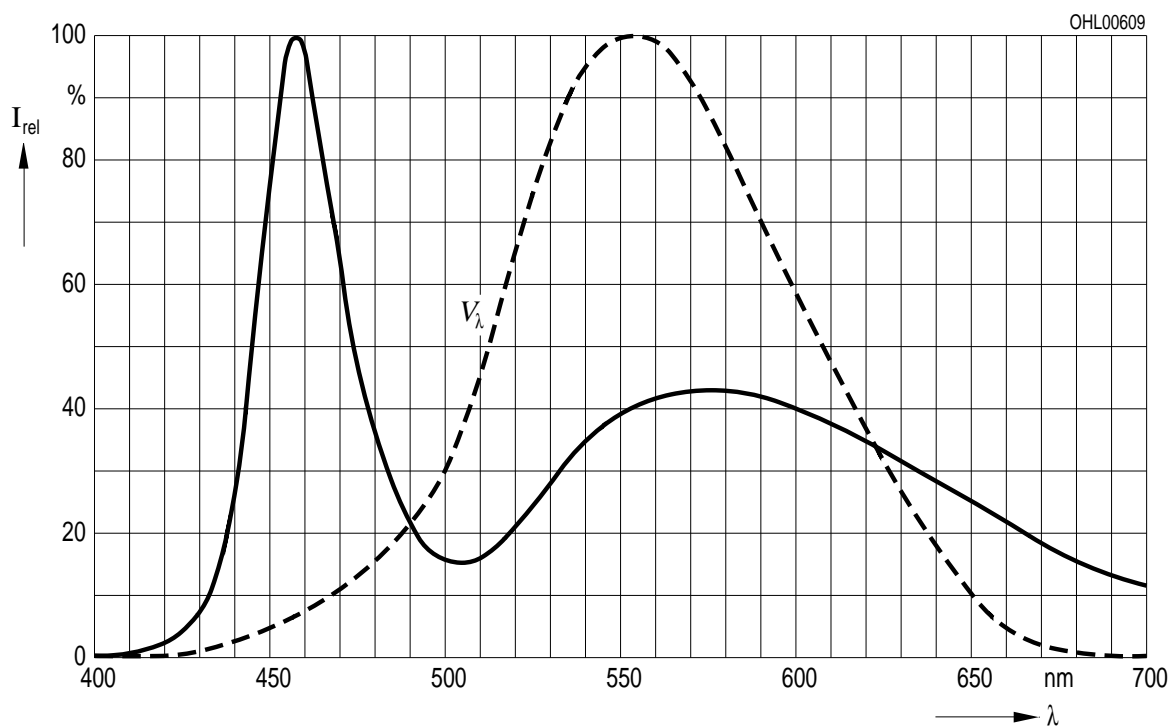
Lichtgruppe Luminous Intensity Group	Halbgruppe Half Group	Farbortgruppe Chromaticity Coordinate Group
R	2	4

Relative spektrale Emission  $I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ °C}$ ,  $I_F = 30\text{ mA}$

**Relative Spectral Emission**

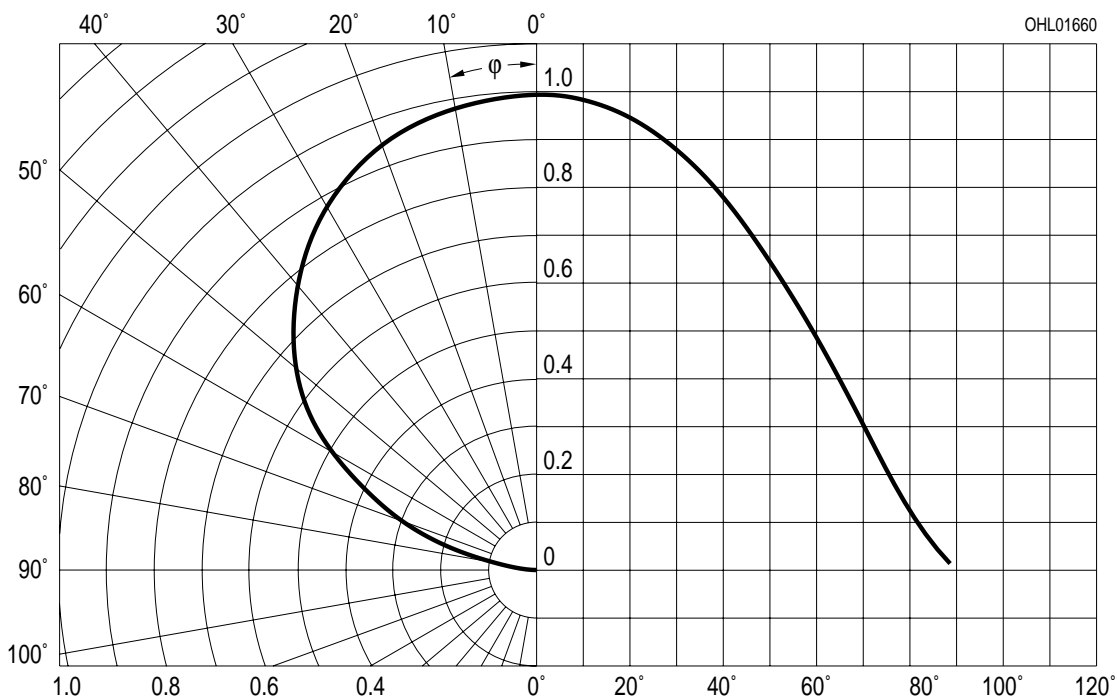
$V(\lambda)$  = spektrale Augenempfindlichkeit

Standard eye response curve



Abstrahlcharakteristik  $I_{rel} = f(\varphi)$

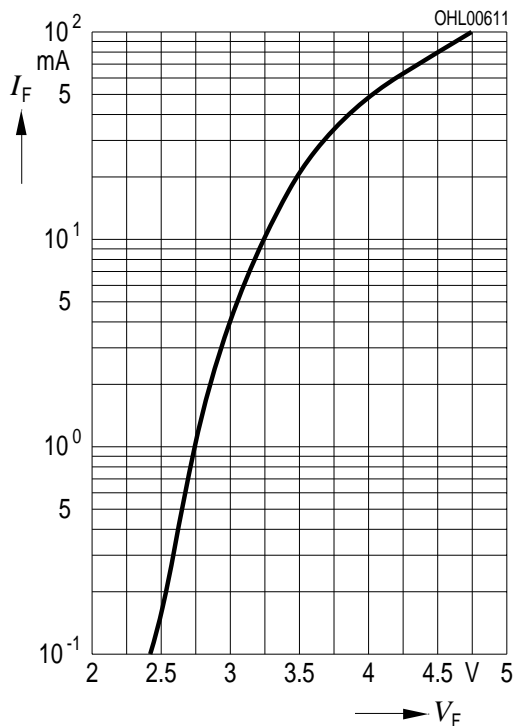
**Radiation Characteristic**



Durchlassstrom  $I_F = f(V_F)$

Forward Current

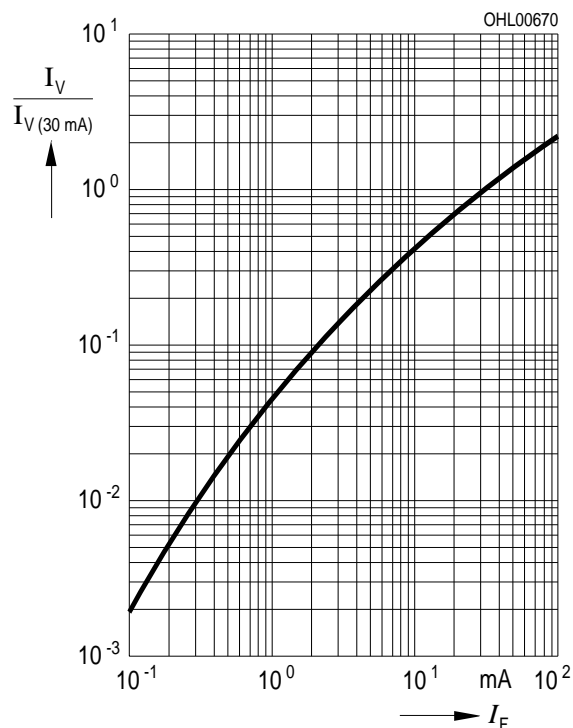
$T_A = 25\text{ }^\circ\text{C}$



Relative Lichtstärke  $I_V/I_{V(30\text{ mA})} = f(I_F)$

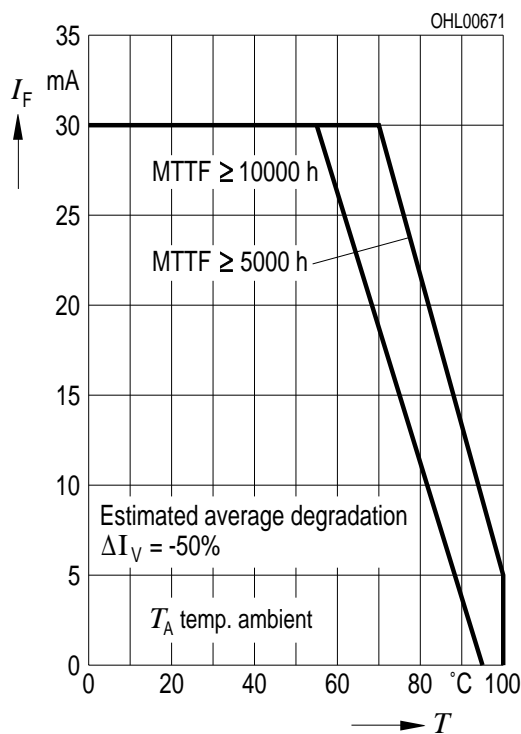
Relative Luminous Intensity

$T_A = 25\text{ }^\circ\text{C}$



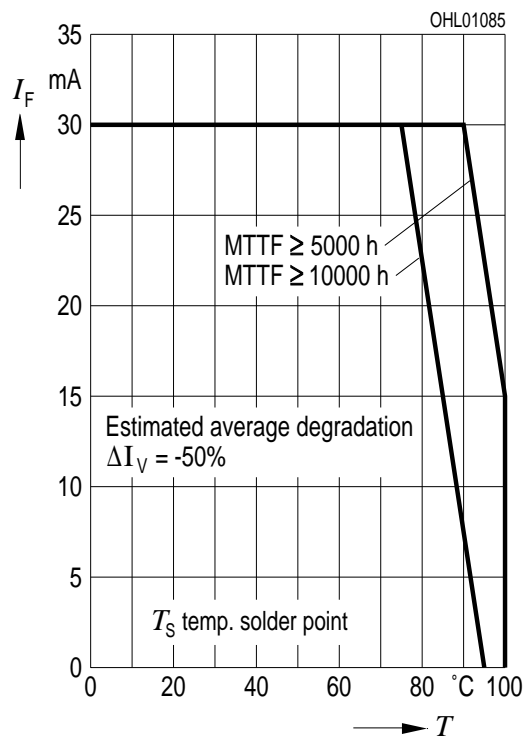
Maximal zulässiger Durchlassstrom  $I_F = f(T)$

Max. Permissible Forward Current



Maximal zulässiger Durchlassstrom  $I_F = f(T)$

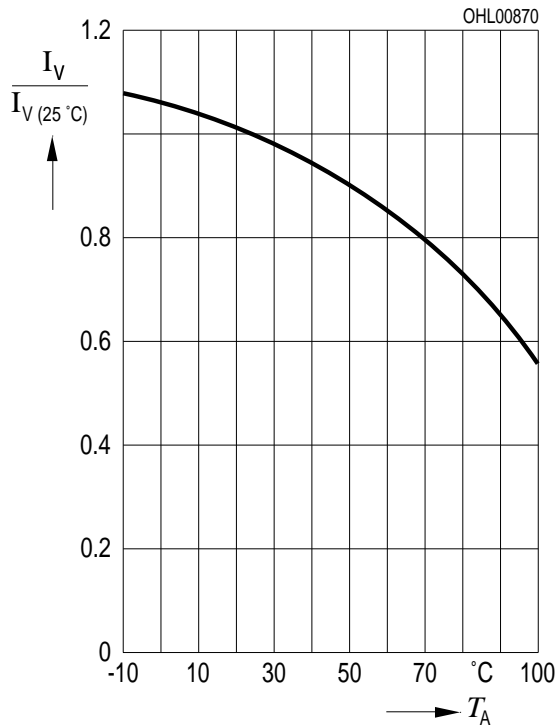
Max. Permissible Forward Current





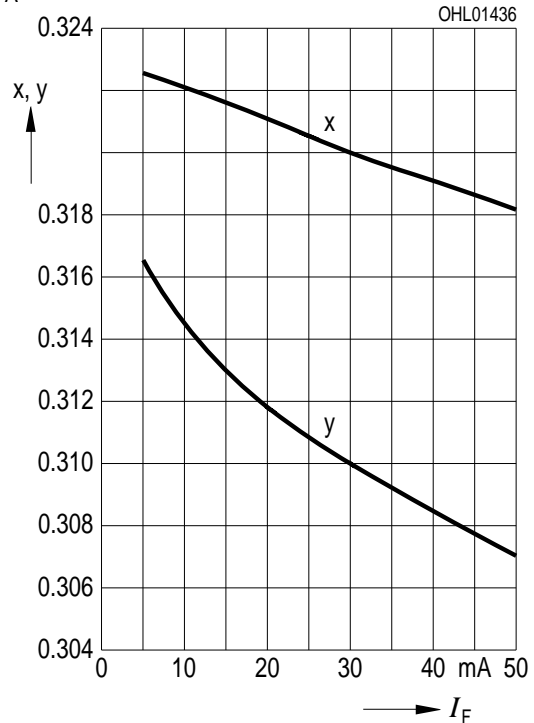
**Relative Lichtstärke  $I_V/I_{V(25^\circ\text{C})} = f(T_A)$**   
**Relative Luminous Intensity**

$I_F = 30 \text{ mA}$



**Farbortverschiebung  $x, y = f(I_F)$**   
**Chromaticity Coordinate Shift**

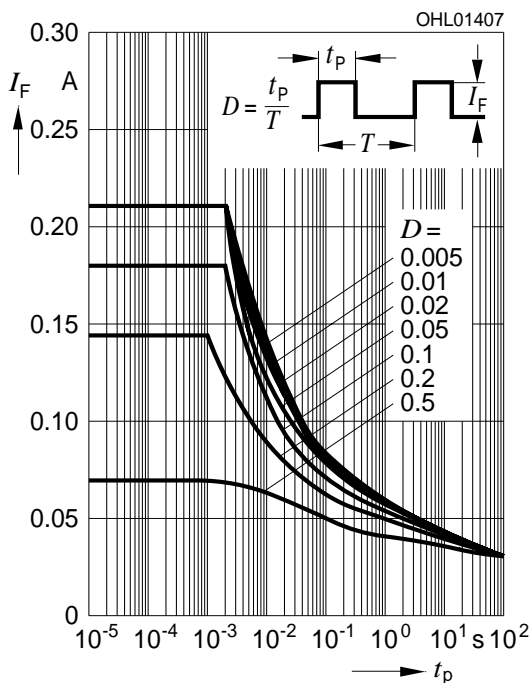
$T_A = 25^\circ\text{C}$



**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**

Duty cycle  $D = \text{parameter}$ ,  $T_A = 25^\circ\text{C}$

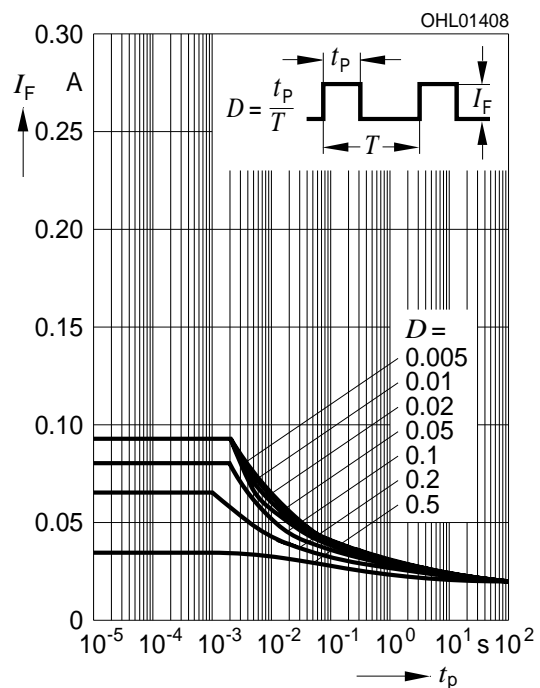
**LW**



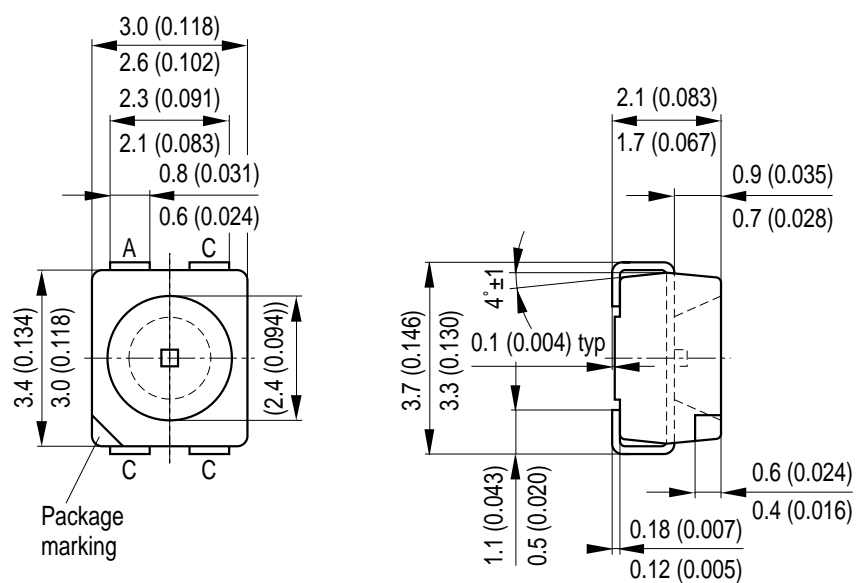
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**

Duty cycle  $D = \text{parameter}$ ,  $T_A = 85^\circ\text{C}$

**LW**



Maßzeichnung  
Package Outlines

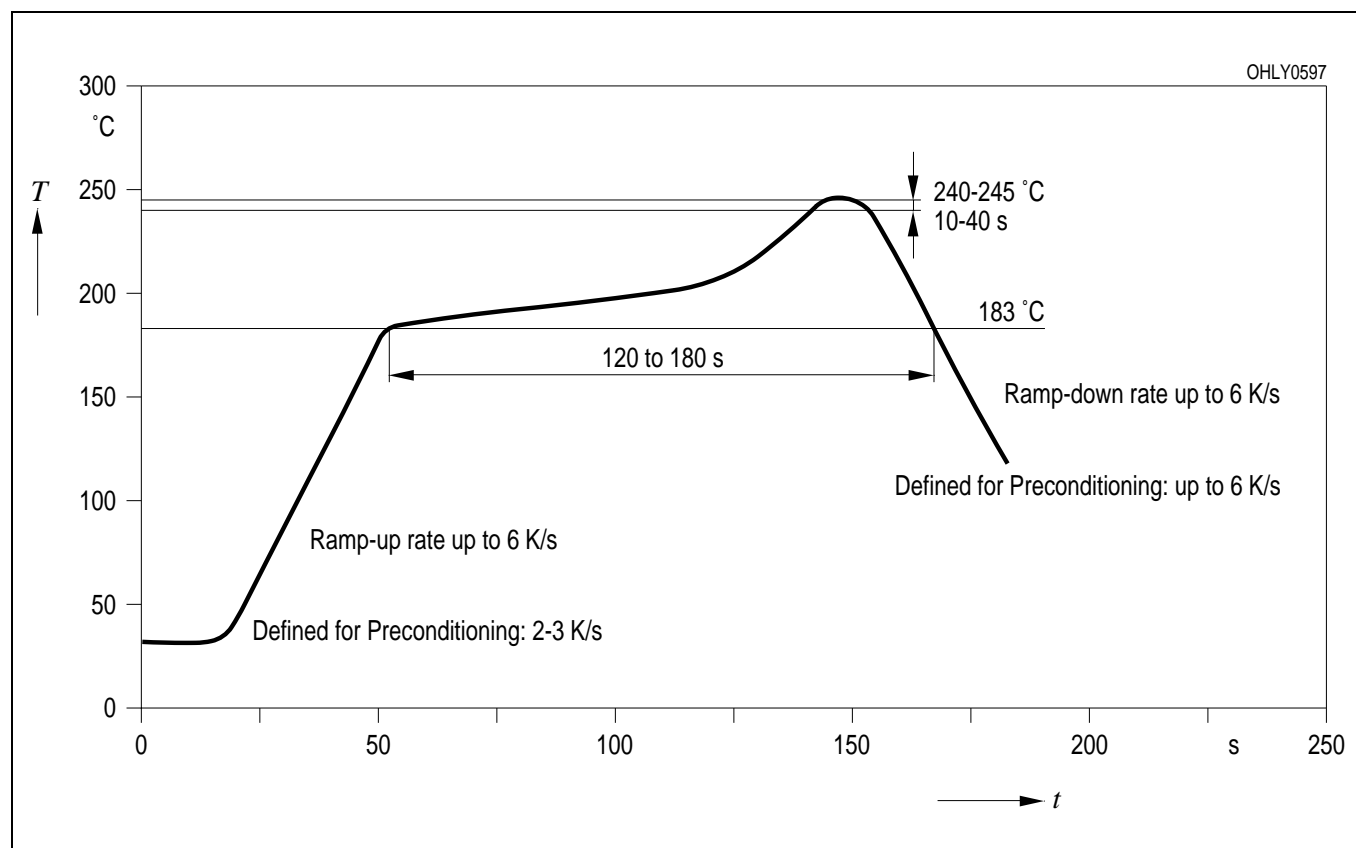


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

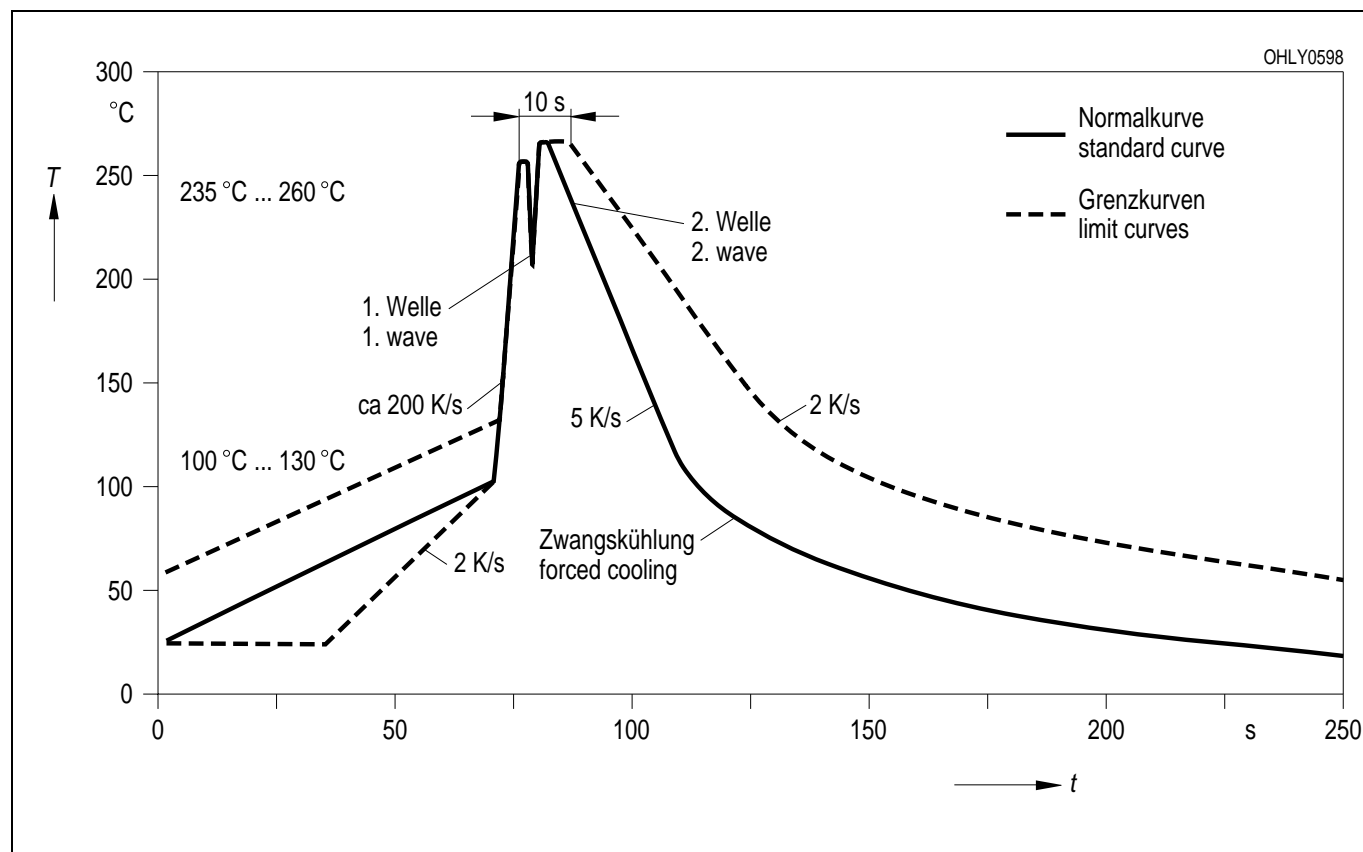
Gewicht / Approx. weight: 31 mg

**Lötbedingungen** Vorbehandlung nach JEDEC Level 2  
**Soldering Conditions** Preconditioning acc. to JEDEC Level 2

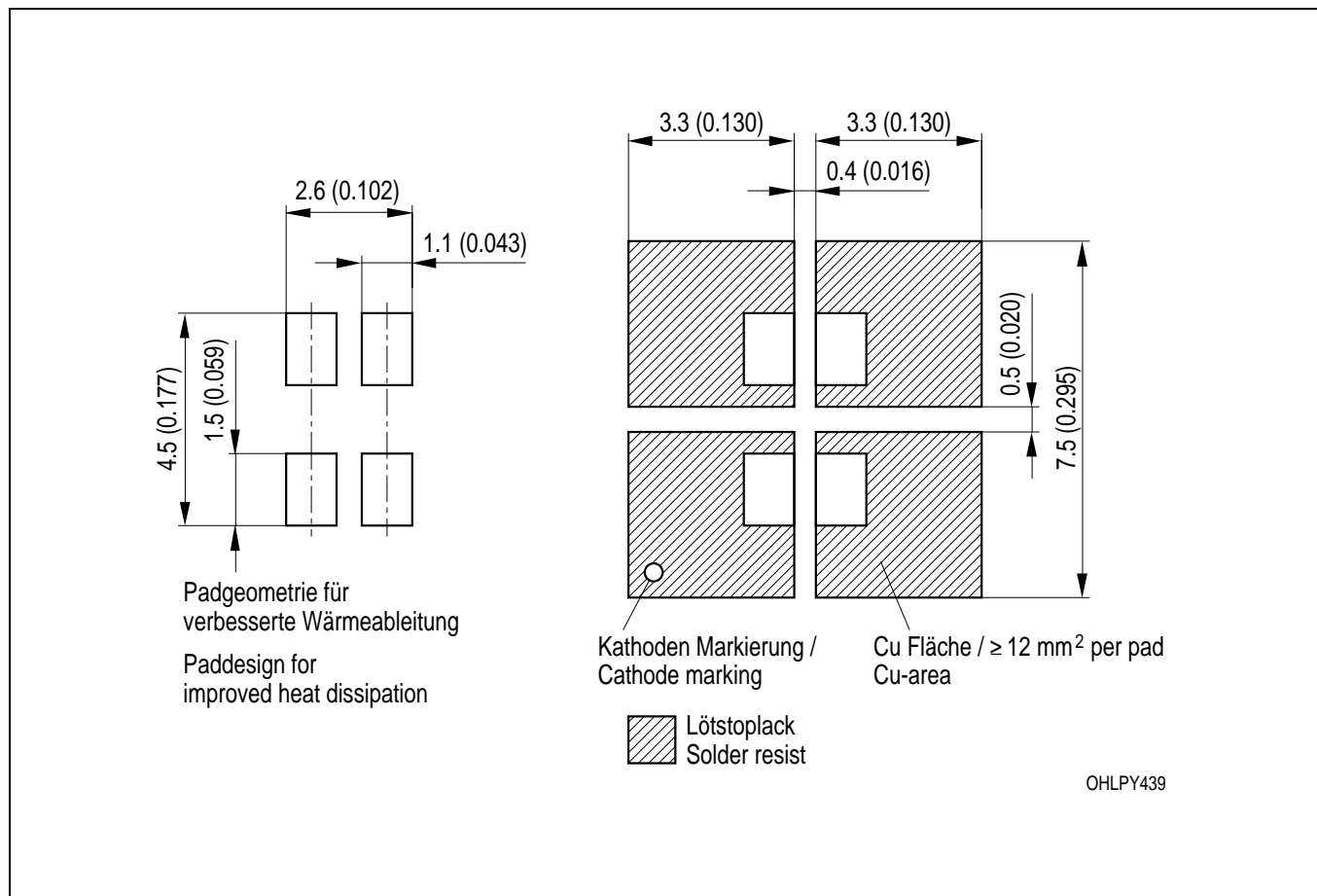
**IR-Reflow Lötprofil** (nach IPC 9501)  
**IR Reflow Soldering Profile** (acc. to IPC 9501)



**Wellenlöten (TTW)** (nach CECC 00802)  
**TTW Soldering** (acc. to CECC 00802)

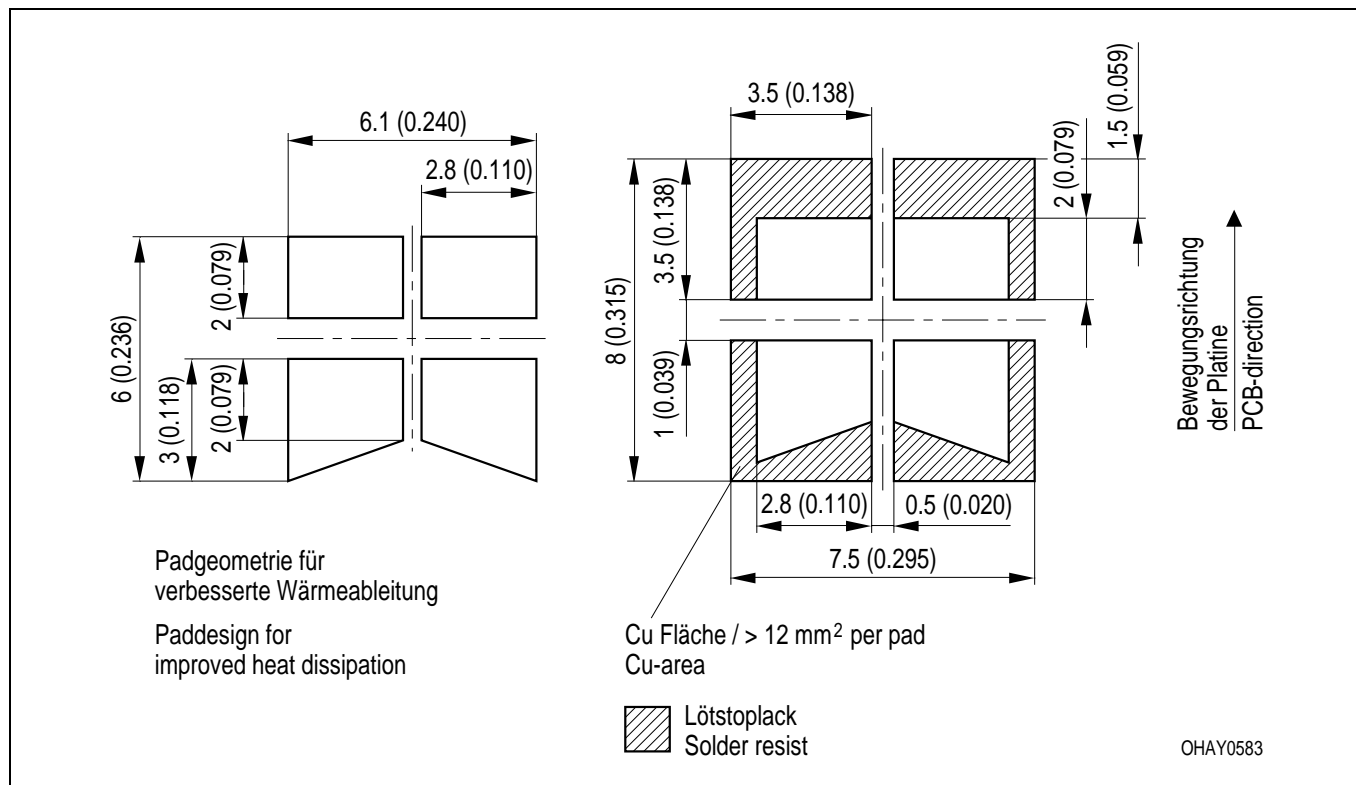


**Empfohlenes Lötpad Design** IR Reflow Löten  
**Recommended Solder Pad** IR Reflow Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch)

**Empfohlenes Lötpad Design** Wellenlöten (TTW)  
**Recommended Solder Pad** TTW Soldering



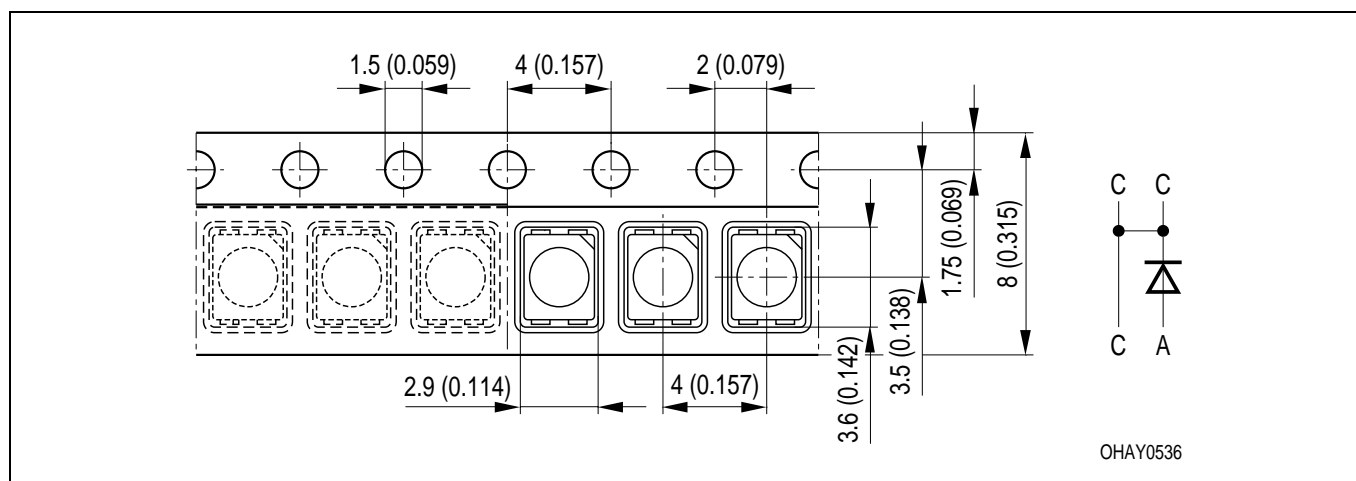
Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch)

**Gurtung / Polarität und Lage**

Verpackungseinheit 2000/Rolle, ø180 mm  
 oder 8000/Rolle, ø330 mm

**Method of Taping / Polarity and Orientation**

Packing unit 2000/reel, ø180 mm  
 or 8000/reel, ø330 mm



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch)

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Page	Subjects (major changes since last revision)

**Patent List****Patent No.**

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